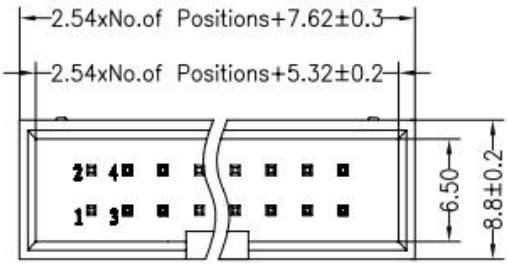
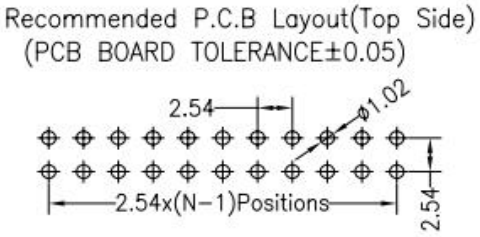
HECON
东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

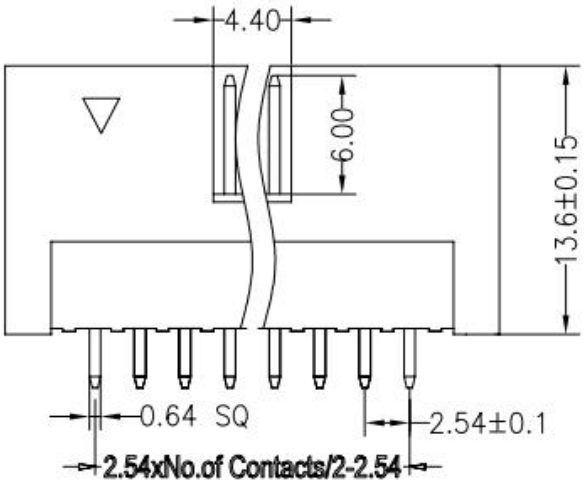
SPECIFICATIONS:

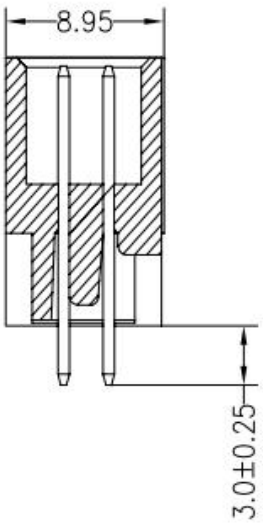
Rated Current	3.0AMP
Contact Resistance	20mΩ Max
Withstand Voltage	1000V AC/DC
Insulation Resistance	1000mΩ Min
Operation Temperature	- 40℃ to +105℃
Contact Material	Brass
Contact Plating	Au over Ni
Insulator Material	PA6T
Max. Processing Temp:	230℃ for 30-60 seconds
	260℃ for 10 seconds











Ordering Information

HC Series	No.of Pin Per Row	Type	Plating	Insulator Option	Inner Code	Packing	End code
HC-BH415	06P	S=Straight	G0=Gold Flash	A=PBT	BK00	0=PE Bag	X
2.54x13.6mm Box Header	64P		SN=Tin Plated	B=PA66		A=Tray	01
			SM=Matted Tin	C=PA6T		T=Tube	02
			S0=Gold/Tin	D=PA46		P=Tube+Cap	
			G1=3u Gold	E=PA9T		R=Reel+Cap	
			G2=5u Gold	F=LCP		M=Reel+Mylar	
			G3=10u Gold	X=Special		X=Special	
			G4=15u Gold				
			G5=30u Gold				
			S1=3u Gold/Tin				